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## Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

## **Listing of Claims:**

- 1. (Currently Amended) A fluid sensor for use in an environment having an ambient temperature, the fluid sensor comprising:
- a) a field-effect transistor (FET) comprising a functionalized semiconductor nanowire, wherein the functionalized semiconductor nano-wire includes a number of materials that each preferentially interacts with a particular fluid to be detected and effects a change of an electrical characteristic of the FET,
- b) an integral heater disposed proximate to the field-effect transistor to heat the field-effect transistor to an elevated temperature relative to the ambient temperature, and
- c) integral thermal insulation disposed to maintain the field-effect transistor at the elevated temperature.
- 2. (Original) The fluid sensor of claim 1, wherein the functionalized semiconductor nano-wire comprises silicon.
- 3. (Original) The fluid sensor of claim 2, wherein the silicon of the functionalized semiconductor nano-wire is doped to provide a predetermined conductivity type.

- 4. (Original) The fluid sensor of claim 1, wherein the functionalized semiconductor nano-wire comprises a catalyst.
- 5. (Original) The fluid sensor of claim 4, wherein the catalyst comprises a material capable of interacting with a fluid to be sensed and effecting a change of an electrical characteristic of the field-effect transistor (FET).
- (Original) The fluid sensor of claim 4, wherein the catalyst comprises a metallic catalyst.
- 7. (Original) The fluid sensor of claim 4, wherein the catalyst is a material selected from the list consisting of platinum, palladium, iridium, rhenium, ruthenium, gold, silver, and mixtures or alloys or compounds thereof; carbon; tungsten, titanium, tin, zinc, and oxides thereof; organometallic compounds containing elements from the group consisting of cobalt, iron, and nickel; and transition metal complexes containing elements from Groups IIIA, IVA, VA, VIA, VIIA, VIIIA, IB, IIB of the Periodic Table of Elements.
- 8. (Original) The fluid sensor of claim 4, wherein the catalyst comprises a porous thin layer of catalyst material.
- 9. (Original) The fluid sensor of claim 8, wherein pores of the porous thin layer of catalyst material extend at least partially through the thin layer of catalyst material.

- 10. (Original) The fluid sensor of claim 4, wherein the catalyst comprises a mesh formed by thin filaments of catalyst material.
- 11. (Original) The fluid sensor of claim 1, wherein the functionalized semiconductor nano-wire comprises a silicon nano-wire functionalized with a material capable of interacting with a fluid to be sensed and effecting a change of an electrical characteristic of the field-effect transistor (FET).
- 12. (Original) The fluid sensor of claim 1, wherein the functionalized semiconductor nano-wire comprises a silicon nano-wire functionalized with a catalyst selected from the list consisting of: platinum, palladium, iridium, rhenium, ruthenium, gold, silver, and mixtures or alloys or compounds thereof; carbon; tungsten, titanium, tin, zinc, and oxides thereof; carbon; tungsten, titanium and oxides thereof; organometallic compounds containing elements from the group consisting of cobalt, iron, and nickel; and transition metal complexes containing elements from Groups IIIA, IVA, VA, VIA, VIIA, VIIIA, IB, IIB of the Periodic Table of Elements.
- 13. (Original) The fluid sensor of claim 1, further comprising a substrate for supporting the field-effect transistor.
- 14. (Original) The fluid sensor of claim 13, wherein the field-effect transistor and the substrate are formed from a layer of silicon on an insulator (SOI).

- 15. (Original) The fluid sensor of claim 14, wherein the field-effect transistor and the substrate are formed from a layer of silicon on an insulator layer comprising silicon oxide.
- 16. (Original) The fluid sensor of claim 13, wherein the integral thermal insulation is disposed on the substrate.
- 17. (Original) The fluid sensor of claim 13, wherein the integral heater is disposed on the substrate.
- 18. (Original) The fluid sensor of claim 13, wherein the integral heater is disposed on the integral thermal insulation.
- 19. (Original) The fluid sensor of claim 13, wherein the field-effect transistor (FET) is disposed on the substrate.
- 20. (Original) The fluid sensor of claim 13, wherein the field-effect transistor (FET) is disposed on the integral thermal insulation.
- 21. (Original) The fluid sensor of claim 13, wherein a portion of the substrate is removed to form an opening under the field-effect transistor (FET), the opening being at least partially aligned with the field-effect transistor.
- 22. (Original) The fluid sensor of claim 13, wherein the substrate serves as a gate for the field-effect transistor.

- 23. (Original) The fluid sensor of claim 13, wherein the field-effect transistor includes a gate electrically insulated from the substrate.
- 24. (Original) The fluid sensor of claim 13, wherein the functionalized semiconductor nano-wire comprises a conductive catalyst electrically insulated from the substrate to provide a gate for the field-effect transistor.
- 25. (Original) The fluid sensor of claim 1, further comprising at least one integral temperature sensor disposed proximate to the field-effect transistor for determining the temperature thereof.
- 26. (Original) A fluid-sensor array, each fluid sensor of the fluid-sensor array comprising the fluid sensor of claim 25.
- 27. (Original) A fluid-sensor array, each fluid sensor of the fluid-sensor array comprising the fluid sensor of claim 1.
- 28. (Original) The fluid-sensor array of claim 27, further comprising at least one integral temperature sensor for determining a temperature thereof.
- 29. (Original) The fluid-sensor array of claim 27, wherein the field-effect transistor of each fluid sensor of the array is functionalized for detecting a particular substance.

- 30. (Original) The fluid-sensor array of claim 27, wherein the field-effect transistor of each fluid sensor of the array is functionalized for detecting a distinct substance.
- 31. (Original) The fluid-sensor array of claim 27, wherein the field-effect transistors of a number of the fluid sensors of the array are functionalized for detecting the same substance.
- 32. (Original) The fluid-sensor array of claim 27, further comprising at least one field-effect transistor not functionalized for detecting a substance, whereby at least one control device is provided.
- 33. (Original) A fluid sensor for use in an environment having an ambient temperature, the fluid sensor comprising:
- a) functionalized nano-scale field-effect-transistor means for detecting a fluid,
- b) integral means for heating the means for detecting a fluid,
- d) integral means for thermally insulating at least the means for detecting a fluid,
  and
- e) means for supporting the means for detecting a fluid, the integral means for heating, and the integral means for thermally insulating.
- 34. (Original) The fluid sensor of claim 33, wherein the integral means for heating comprises means for heating the means for detecting a fluid to an elevated temperature relative to the ambient temperature, and the integral means for thermally insulating comprises means for maintaining the means for detecting a fluid at the elevated temperature.

- 35. (Original) The fluid sensor of claim 33, further comprising integral means for determining the temperature of the means for detecting a fluid.
- 36. (Original) The fluid sensor of claim 33, wherein the means for detecting a fluid comprises means for detecting a gas.
- 37. (Original) A method for fabricating a fluid sensor, the method comprising the steps of:
- a) providing an insulating substrate,
- b) depositing a layer of silicon on the insulating substrate to form a silicon-oninsulator (SOI) substrate,
- c) patterning the layer of silicon to form at least one silicon nano-wire and at least one integral heater resistor,
- d) forming conductive source and drain contacts, thereby combining the source and drain contacts with the semiconductor nano-wire to form a field-effect transistor,
- e) functionalizing the at least one silicon nano-wire for detection of at least one gas, and
- f) depositing thermal insulation disposed to maintain the field-effect transistor at an elevated temperature relative to the ambient temperature of the fluid sensor.
- 38. (Original) The method of claim 37, wherein the silicon-layer patterning step c) is performed by nanolithography.

- 39. (Original) The method of claim 37, wherein the silicon-layer patterning step c) is performed using a lithography method selected from the list consisting of nano-imprint lithography, electron-beam lithography, ion-beam lithography, deep-UV lithography, and X-ray lithography.
- 40. (Original) The method of claim 37, wherein the step d) of forming conductive source and drain contacts is performed by nanolithography.
- 41. (Original) The method of claim 37, wherein the step d) of forming conductive source and drain contacts is performed using a lithography method selected from the list consisting of nano-imprint lithography, electron-beam lithography, ion-beam lithography, deep-UV lithography, and X-ray lithography.
- 42. (Original) The method of claim 37, wherein the step of functionalizing the at least one silicon nano-wire comprises depositing a quantity of a material capable of interacting with a fluid to be sensed and effecting a change of an electrical characteristic of the field-effect transistor (FET).
- 43. (Original) The method of claim 37, wherein the step of functionalizing the at least one silicon nano-wire comprises depositing a quantity of catalyst on the silicon nano-wire.
- 44. (Original) The method of claim 37, wherein the step of functionalizing the at least one silicon nano-wire comprises depositing on the silicon nano-wire a quantity of a catalyst selected from the list consisting of: platinum, palladium, iridium, rhenium, ruthenium, gold, silver, and mixtures or alloys or compounds thereof;

carbon; tungsten, titanium, tin, zinc, and oxides thereof; organometallic compounds containing elements from the group consisting of cobalt, iron, and nickel; and transition metal complexes containing elements from Groups IIIA, IVA, VA, VIA, VIIA, VIIIA, IB, IIB of the Periodic Table of Elements.

- 45. (Original) The method of claim 37, wherein the step of functionalizing the at least one silicon nano-wire includes forming a gate for the field-effect transistor (FET).
- 46. (Original) The method of claim 37, further comprising the step of removing at least a portion of the substrate under the field-effect transistor (FET).
- 47. (Original) The method of claim 46, wherein the step of removing at least a portion of the substrate is performed by etching the back side of the substrate to form an opening at least partially aligned with the field-effect transistor (FET).
- 48. (Original) The method of claim 37, further comprising the steps of patterning the semiconductor film and forming a junction to make a diode with known temperature-dependent electrical characteristics, whereby an integral temperature sensor is formed.
- 49. (Original) A fluid sensor fabricated by the method of claim 48.
- 50. (Original) A method of using the fluid sensor of claim 49, comprising the steps of:
- a) associating with each of two or more fluids to be sensed a different operating temperature range effective for sensing the fluid to be sensed,

- b) sensing a temperature of the fluid sensor by operating the integral temperature sensor, and
  - c) actuating the integral heater to adjust the temperature of the fluid sensor to within a selected operating temperature range, whereby one of the two or more fluids to be sensed is selected for sensing.
  - 51. (Original) A fluid sensor fabricated by the method of claim 37.
  - 52. (Original) An integrated circuit comprising the fluid sensor of claim 51.
  - 53. (Original) A fluid-sensor array, each fluid sensor of the fluid-sensor array being fabricated by the method of claim 37.
  - 54. (Original) An integrated circuit comprising the fluid-sensor array of claim 53.
  - 55. (Original) A method of using a fluid sensor having an integral heater and an integral temperature sensor, the method comprising the steps of:
  - a) associating with each of two or more fluids to be sensed a different operating temperature range effective for sensing the fluid to be sensed,
  - b) sensing a temperature of the fluid sensor by operating the integral temperature sensor, and
  - c) actuating the integral heater to adjust the temperature of the fluid sensor to within a selected operating temperature range, whereby one of the two or more fluids to be sensed is selected for sensing.